



**Part Number :** [15800123](#)

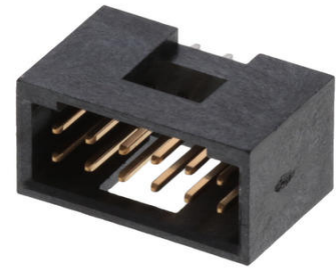
**Product Description :** 2.54mm Pitch C-Grid Header, Through Hole without Peg, Dual Row, Vertical, Shrouded, High Temperature, 12 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating

**Series Number :** 70567

**Status :** Active

**Product Category :** PCB Headers and Receptacles

**Engineering Number :** A-70567-0072



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## Documents & Resources

### Drawings

[015800123\\_sd.pdf](#)

[PK-70873-0018-001.pdf](#)

### 3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)

[Symbol and Footprint \(Multi-Format\)](#)


### Specifications

[PS-70567-001.pdf](#)

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## Product Environment Compliance

### Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

### Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

### Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

### Substances of Interest

- PFAS

### EU RoHS Certificate of Compliance

### Additional Product Compliance Information

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## Part Details

### General

Status	Active
Category	PCB Headers and Receptacles
Series	70567
Description	2.54mm Pitch C-Grid Header, Through Hole without Peg, Dual Row, Vertical, Shrouded, High Temperature, 12 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid
UPC	800754210911

### Agency

UL	E29179
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### Electrical

Current - Maximum per Contact	2.5A
Voltage - Maximum	250V

## Physical

Breakaway	No
Circuits (Loaded)	12
Circuits (maximum)	12
Color - Resin	Black
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	2.217/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	Yes
PCB Thickness - Recommended	2.40mm
PC Tail Length	3.30mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	Yes
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

## Solder Process Data

Max-Duration	5
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	1
Max-Temp	245

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## Mates With / Use With

### Mates with Part(s)

Description	Part Number
C-Grid Vertical, Dual Row, High Profile, Surface Mount PCB Connectors	<u>71395</u>
C-Grid Vertical, Dual Row, High Profile, Through Hole PCB Receptacles	<u>71850</u>
SL Dual Row Crimp Housings	<u>70450</u>